



# FX602

N-Channel Silicon MOSFET

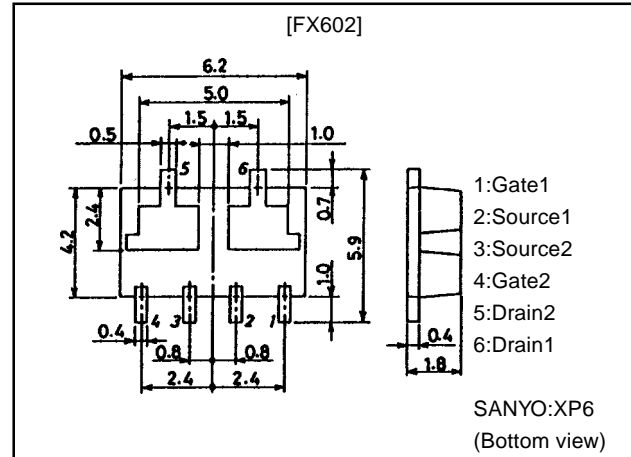
## Ultrahigh-Speed Switching Applications

### Features

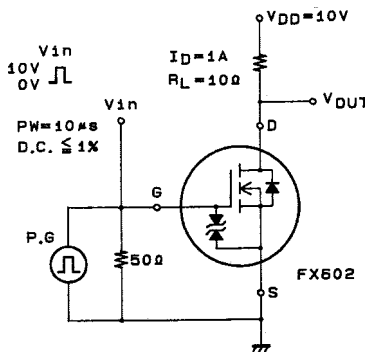
- Composite type composed of two low ON-resistance N-channel MOSFET chips for ultrahigh-speed switching and low-voltage drive.
- Facilitates high-density mounting.
- The FX602 is formed with two chips, each being equivalent to the 2SK2152, placed in one package.
- Matched pair characteristics.

### Package Dimensions

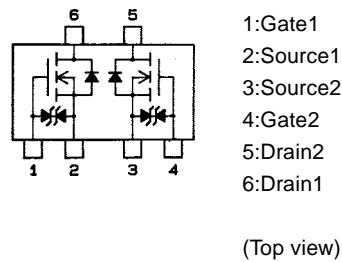
unit:mm  
2120



### Switching Time Test Circuit



### Electrical Connection



### Specifications

#### Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	$V_{DSS}$		20	V
Gate-to-Source Voltage	$V_{GSS}$		$\pm 15$	V
Drain Current (DC)	$I_D$		2	A
Drain Current (Pulse)	$I_{DP}$	$PW \leq 10\mu s$ , duty cycle $\leq 1\%$	8	A
Allowable Power Dissipation	$P_D$	$T_c = 25^\circ C$ , 1unit	6	W
	$P_D$	Mounted on ceramic board (750mm <sup>2</sup> × 0.8mm) 1unit	1.5	W
Total Dissipation	$P_T$	Mounted on ceramic board (750mm <sup>2</sup> × 0.8mm)	2	W
Channel Temperature	$T_{ch}$		150	°C
Storage Temperature	$T_{stg}$		-55 to +150	°C

· Marking:602

Continued on next page.

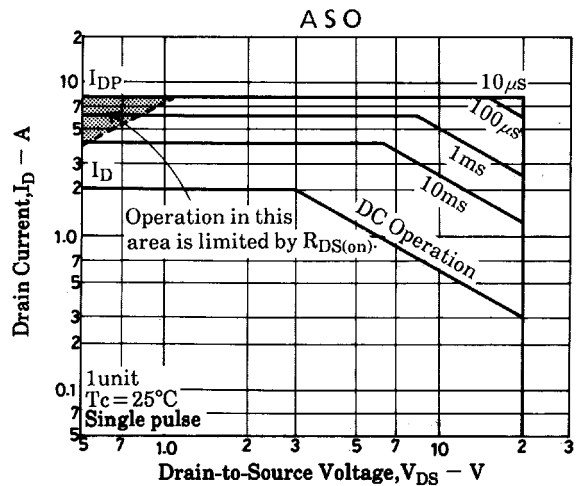
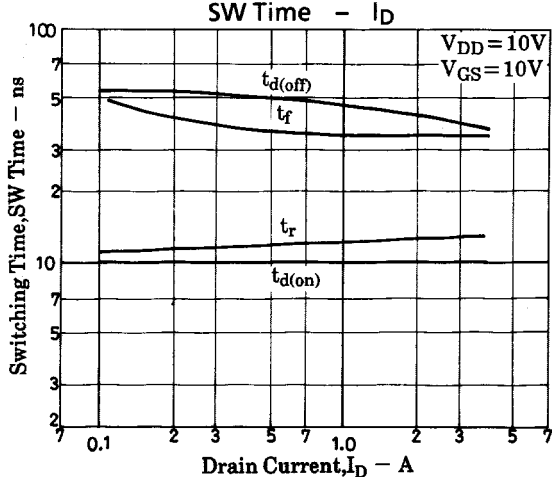
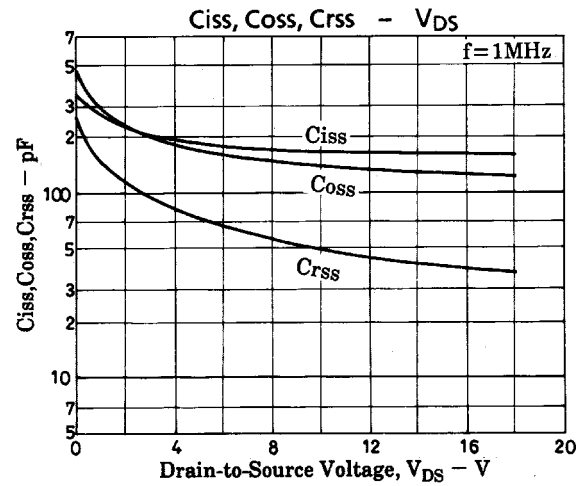
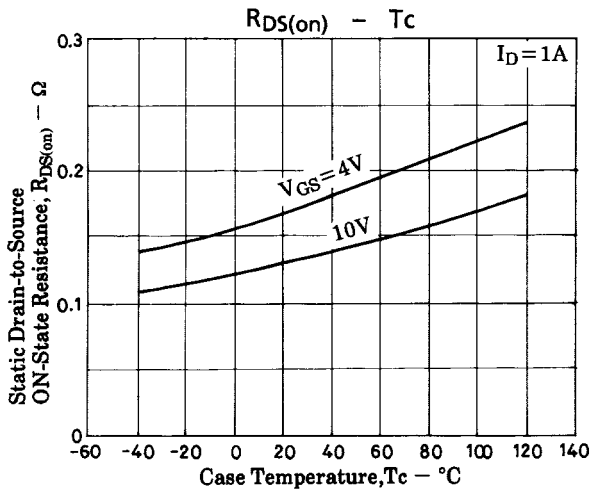
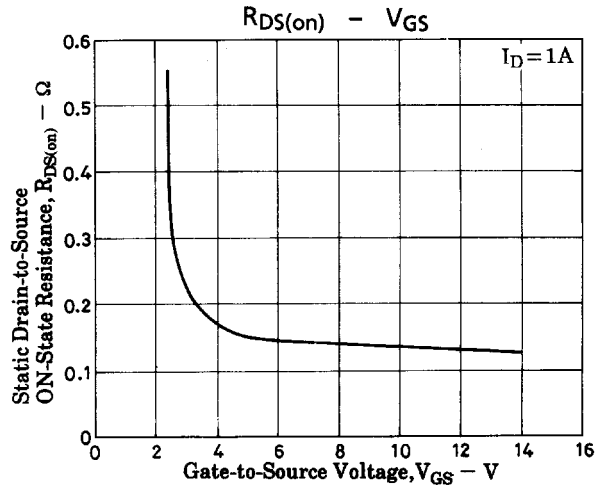
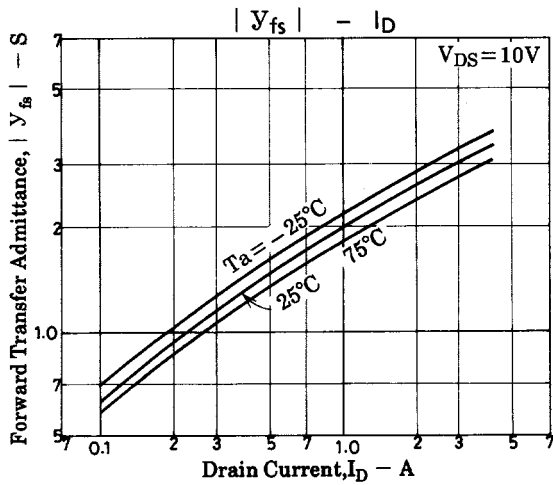
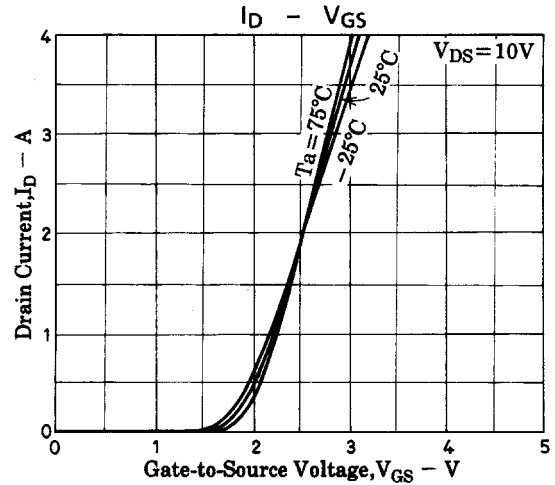
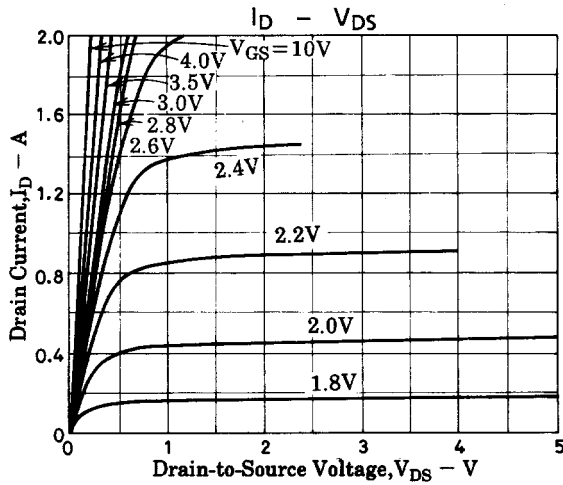
## FX602

Continued from preceding page.

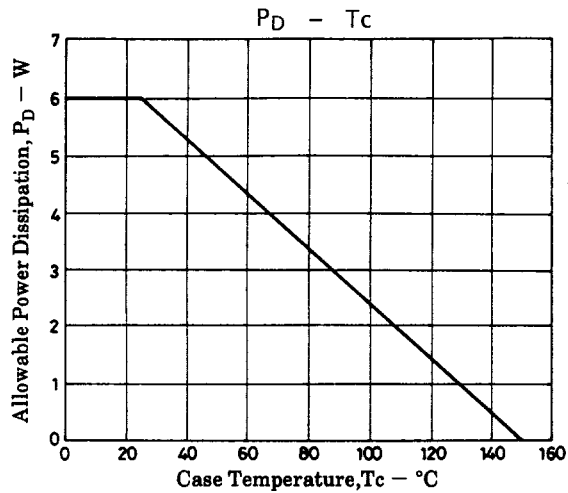
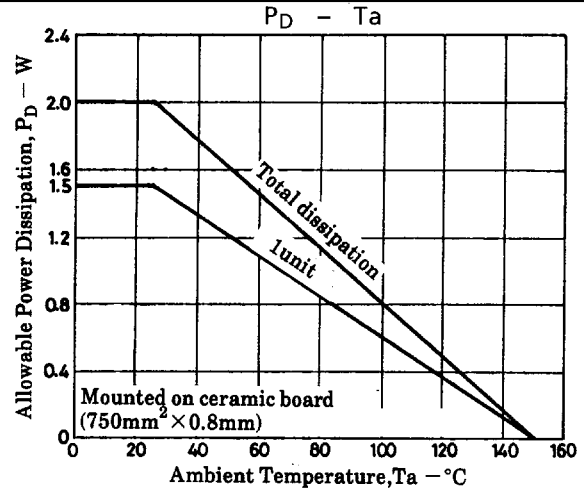
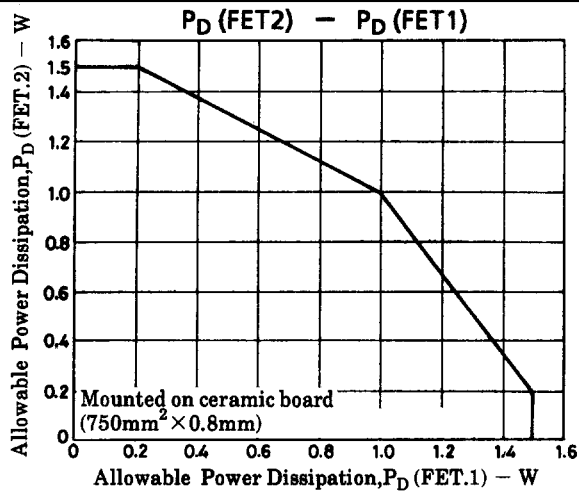
### Electrical Characteristics at Ta = 25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
D-S Breakdown Voltage	$V_{(BR)DSS}$	$I_D=1mA, V_{GS}=0$	20			V
G-S Breakdown Voltage	$V_{(BR)GSS}$	$I_G=\pm 100\mu A, V_{DS}=0$	$\pm 15$			V
Zero-Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=20V, V_{GS}=0$			100	$\mu A$
Gate-to-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 12, V_{DS}=0$			$\pm 10$	$\mu A$
Cutoff Voltage	$V_{GS(off)}$	$V_{GS}=10V, I_D=1mA$	0.8		2.0	V
Forward Transfer Admittance	$ Y_{fs} $	$V_{DS}=10V, I_D=1A$	1.2	2		S
Static Drain-to-Source ON-State Resistance	$R_{DS(on)}$	$I_D=1A, V_{GS}=10V$		130	180	$m\Omega$
	$R_{DS(on)}$	$I_D=1A, V_{GS}=4V$		170	250	$m\Omega$
Input Capacitance	$C_{iss}$	$V_{DS}=10V, f=1MHz$		170		pF
Output Capacitance	$C_{oss}$	$V_{DS}=10V, f=1MHz$		145		pF
Reverse Transfer Capacitance	$C_{rss}$	$V_{DS}=10V, f=1MHz$		50		pF
Turn-ON Delay Time	$t_{d(on)}$	See Specified Test Circuit		10		ns
Rise Time	$t_r$	See Specified Test Circuit		12		ns
Turn-OFF Delay Time	$t_{d(off)}$	See Specified Test Circuit		50		ns
Fall Time	$t_f$	See Specified Test Circuit		35		ns
Diode Forward Voltage	$V_{SD}$	$I_S=2A, V_{GS}=0$		1.0		V

# FX602



# FX602



■ No products described or contained herein are intended for use in surgical implants, life-support systems, aerospace equipment, nuclear power control systems, vehicles, disaster/crime-prevention equipment and the like, the failure of which may directly or indirectly cause injury, death or property loss.

■ Anyone purchasing any products described or contained herein for an above-mentioned use shall:

- ① Accept full responsibility and indemnify and defend SANYO ELECTRIC CO., LTD., its affiliates, subsidiaries and distributors and all their officers and employees, jointly and severally, against any and all claims and litigation and all damages, cost and expenses associated with such use:
- ② Not impose any responsibility for any fault or negligence which may be cited in any such claim or litigation on SANYO ELECTRIC CO., LTD., its affiliates, subsidiaries and distributors or any of their officers and employees jointly or severally.

■ Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. SANYO believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.

This catalog provides information as of May, 1998. Specifications and information herein are subject to change without notice.